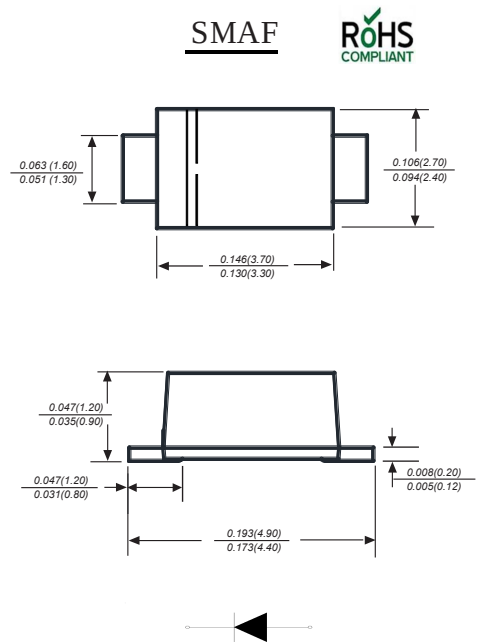


SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Metal silicon junction, majority carrier conduction
- ◆ Low power loss, high efficiency
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:
260 °C/10 seconds at terminals



Dimensions in inches and (millimeters)

Mechanical Data

Case : JEDEC SMAF molded plastic body
Terminals : Solderable per MIL-STD-750, Method 2026
Polarity : Color band denotes cathode end
Mounting Position : Any
Weight : 0.00095 ounce, 0.027grams

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter											
Marking Code	SYMBOLS	SS22F	SS23F	SS24F	SS25F	SS26F	SS28F	SS210F	SS2150F	SS2200F	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	80	100	150	200	V
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	56	70	105	140	V
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	80	100	150	200	V
Maximum average forward rectified current	I _(AV)	2.0									A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	50									A
Maximum instantaneous forward voltage at 2.0A	V _F	0.55			0.70		0.85		0.95		V
Maximum DC reverse current T _A =25℃ at rated DC blocking voltage T _A =100℃	I _R	0.5 5.0					0.3 3.0			mA	
Typical junction capacitance (NOTE 1)	C _J	160			80						pF
Typical thermal resistance (NOTE 2)	R _{θJA}	80.0									℃/W
Operating junction temperature range	T _J	- 5 5 to + 1 2 5				- 5 5 to + 1 5 0					℃
Storage temperature range	T _{STG}	- 5 5 to + 1 5 0									℃

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. P.C.B. mounted with 2.0"x2.0" (5.0x5.0cm) copper pad areas

Typical Characteristics

Fig.1 Forward Current Derating Curve

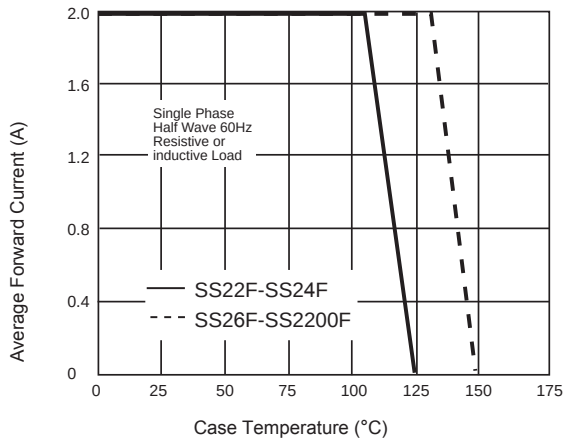


Fig.2 Typical Reverse Characteristics

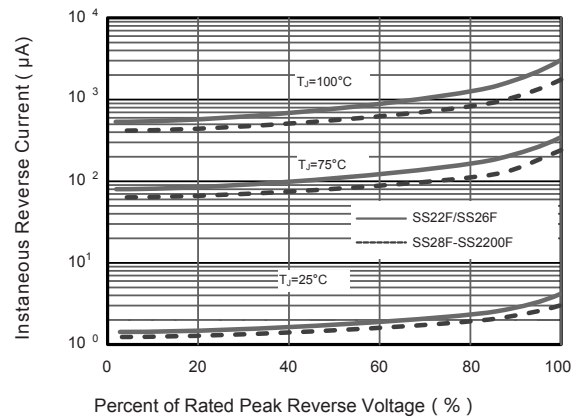


Fig.3 Typical Forward Characteristic

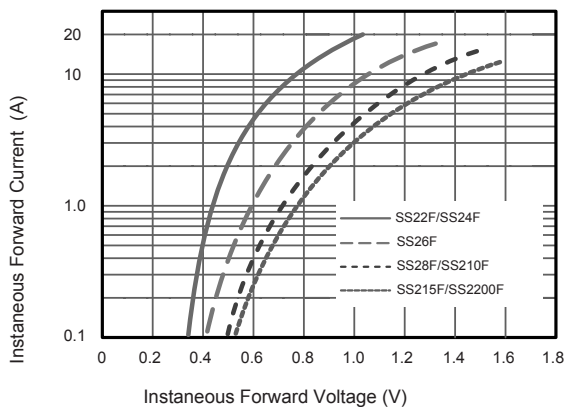


Fig.4 Typical Junction Capacitance

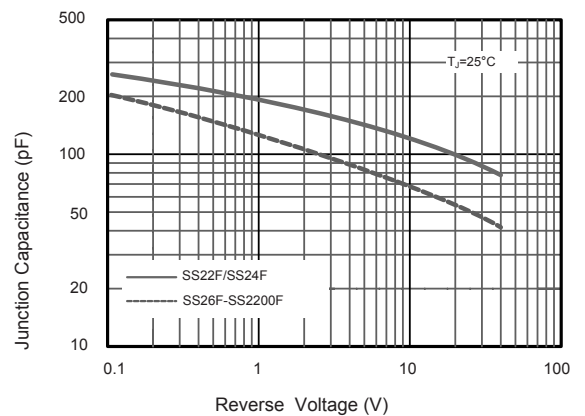


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

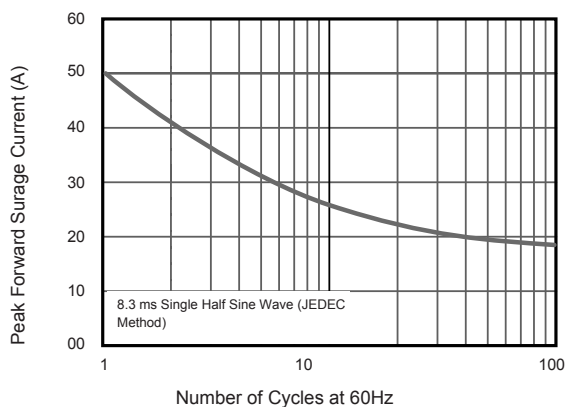
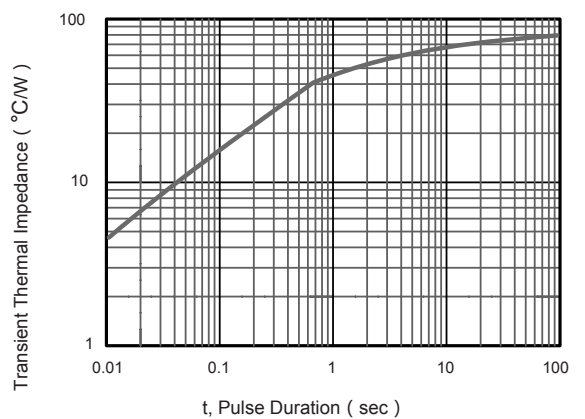


Fig.6- Typical Transient Thermal Impedance



The curve above is for reference only.